

# Surface Mount RF Transformer

50Ω 0.25 to 400 MHz

## TC1-42+



Generic photo used for illustration purposes only

CASE STYLE: AT224-1A

**+RoHS Compliant**

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

**Available Tape and Reel at no extra cost**

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

### Features

- plastic base with solder plated leads
- excellent amplitude unbalance, 0.2 dB typ. and phase unbalance, 3 deg. typ. in 1dB bandwidth
- aqueous washable

### Applications

- balanced to unbalanced
- push-pull amplifier

### Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			1		Ohm
Frequency Range		0.25		400	MHz
Insertion Loss*		0.25-400	3		dB
		0.35-250	2		
		0.7-150	1		

\*Insertion Loss is referenced to mid-band loss, 0.3 dB typ.

### Maximum Ratings

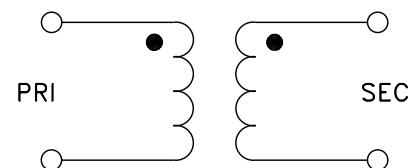
Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

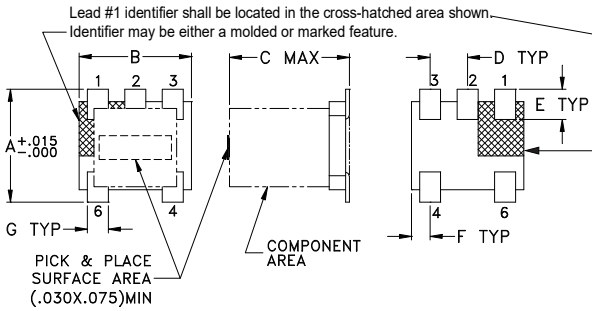
### Pin Connections

Function	Pin Number
PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	1
SECONDARY	3
NOT USED	2.5

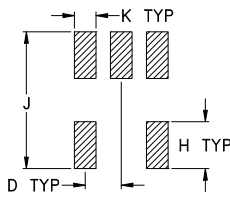
### Config. C



## Outline Drawing

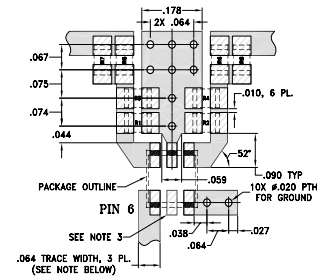


## PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

## Demo Board MCL P/N: TB-77 Suggested PCB Layout (PL-243)



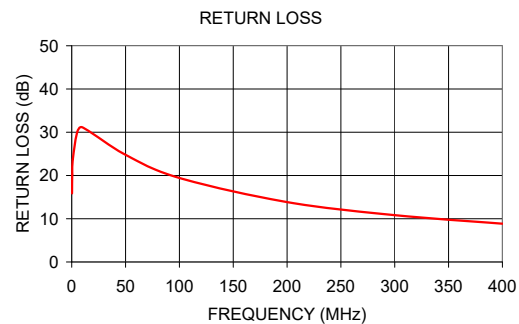
- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS  $.030 \pm .002$ ; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.  
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.  
3. THIS PAD IS NOT REQUIRED FOR AT224 CASE STYLES.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
  - DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

## Outline Dimensions (inch)

A	B	C	D	E	F
.150	.150	.160	.050	.040	.025
3.81	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

## Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
0.25	0.79	15.85
0.50	0.63	20.29
1.00	0.52	23.72
5.00	0.34	29.93
10.00	0.30	31.13
50.00	0.37	24.78
100.00	0.48	19.43
200.00	0.69	13.85
300.00	0.95	10.83
400.00	1.44	8.85



## Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.  
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.  
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at [www.minicircuits.com/MCLStore/terms.jsp](http://www.minicircuits.com/MCLStore/terms.jsp)


# RF Transformer

# TC1-42+

## Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.25	0.79	15.85
0.50	0.63	20.29
1.00	0.52	23.72
5.00	0.34	29.93
10.00	0.30	31.13
50.00	0.37	24.78
100.00	0.48	19.43
200.00	0.69	13.85
300.00	0.95	10.83
400.00	1.44	8.85

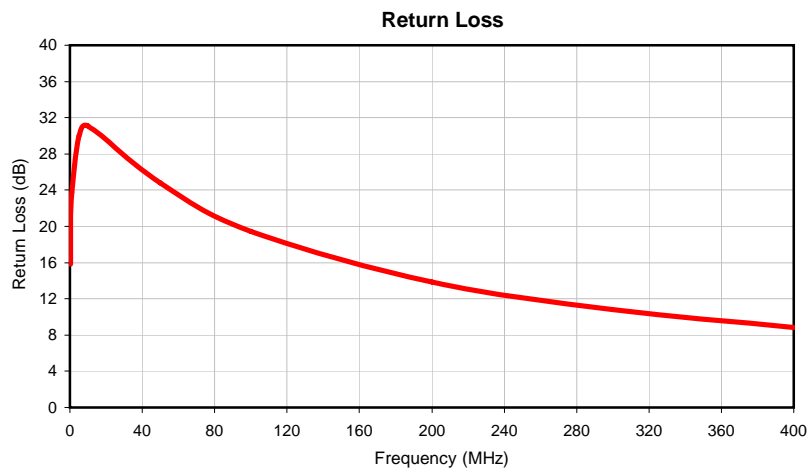
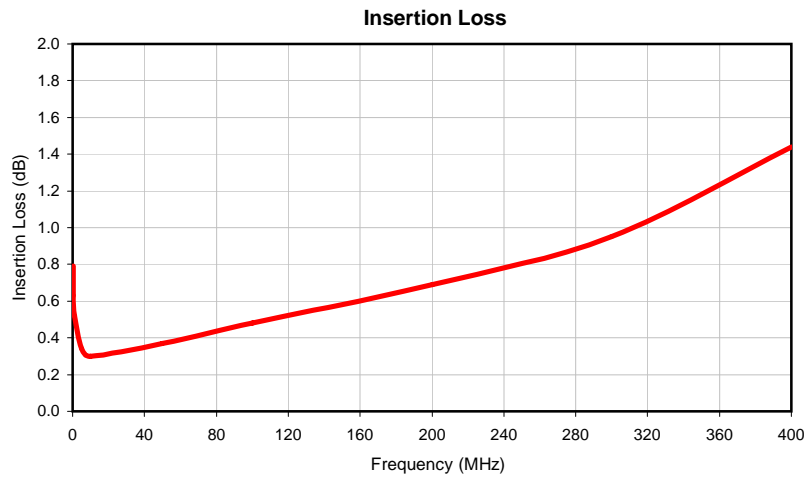


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IF/RF MICROWAVE COMPONENTS

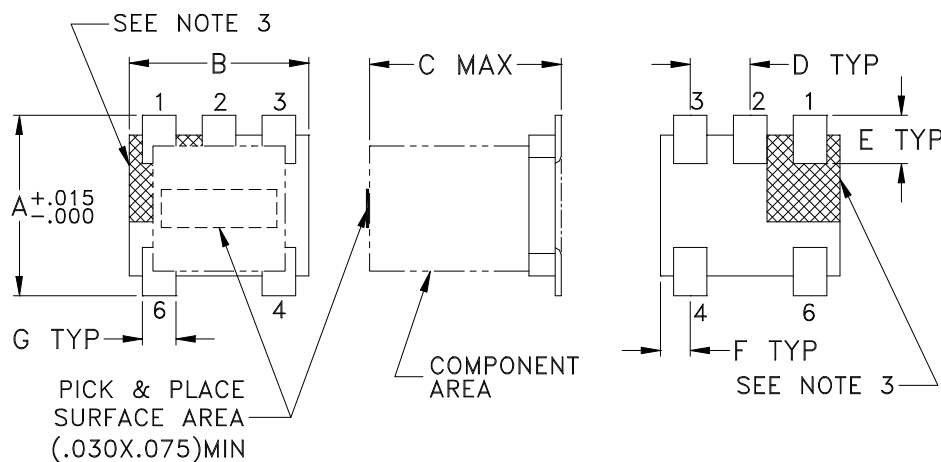
REV. X1  
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Page 1 of 1

## Typical Performance Data

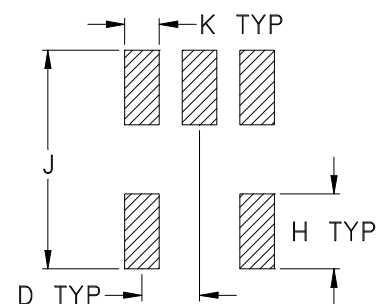


## Outline Dimensions

AT224-1A



## PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAMS
AT224-1A	.150 (3.81)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .01$ ; 3 Pl.  $\pm .005$

### Notes:

- Case material: Plastic.
- Termination finish:  
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown.  
Identifier may be either a molded or marked feature.



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RF/MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F17

## DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
		2000		

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



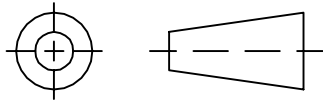
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RF/IF MICROWAVE COMPONENTS

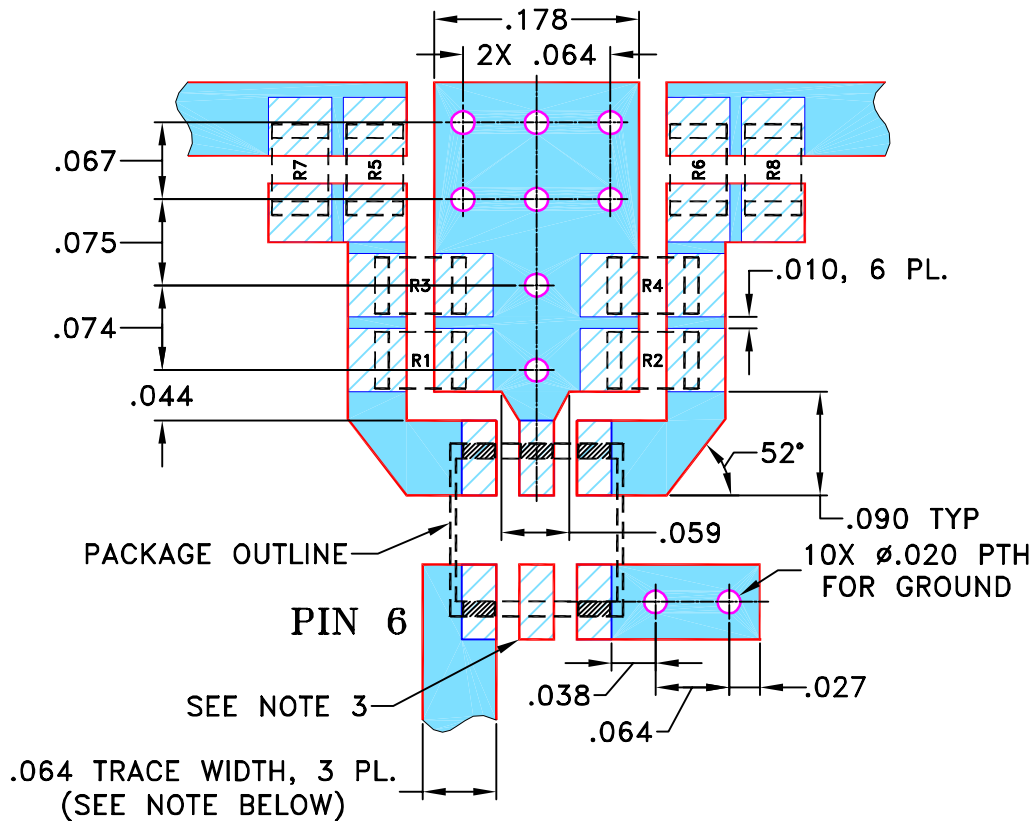
THIRD ANGLE PROJECTION



REVISIONS

REV OR	ECN No.	DESCRIPTION	DATE	DR	AUTH
	M106588	NEW RELEASE	08/28/06	AV	IG

SUGGESTED MOUNTING CONFIGURATION FOR AT224/DB714 CASE STYLES, "gs/ha/hd" PIN CONNECTIONS



RESISTORS R1-R8: 0805 SIZE

- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" ± .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.  
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UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DRAWN	AV	07/31/06
CHECKED	IL	08/28/06
APPROVED	IG	08/28/06

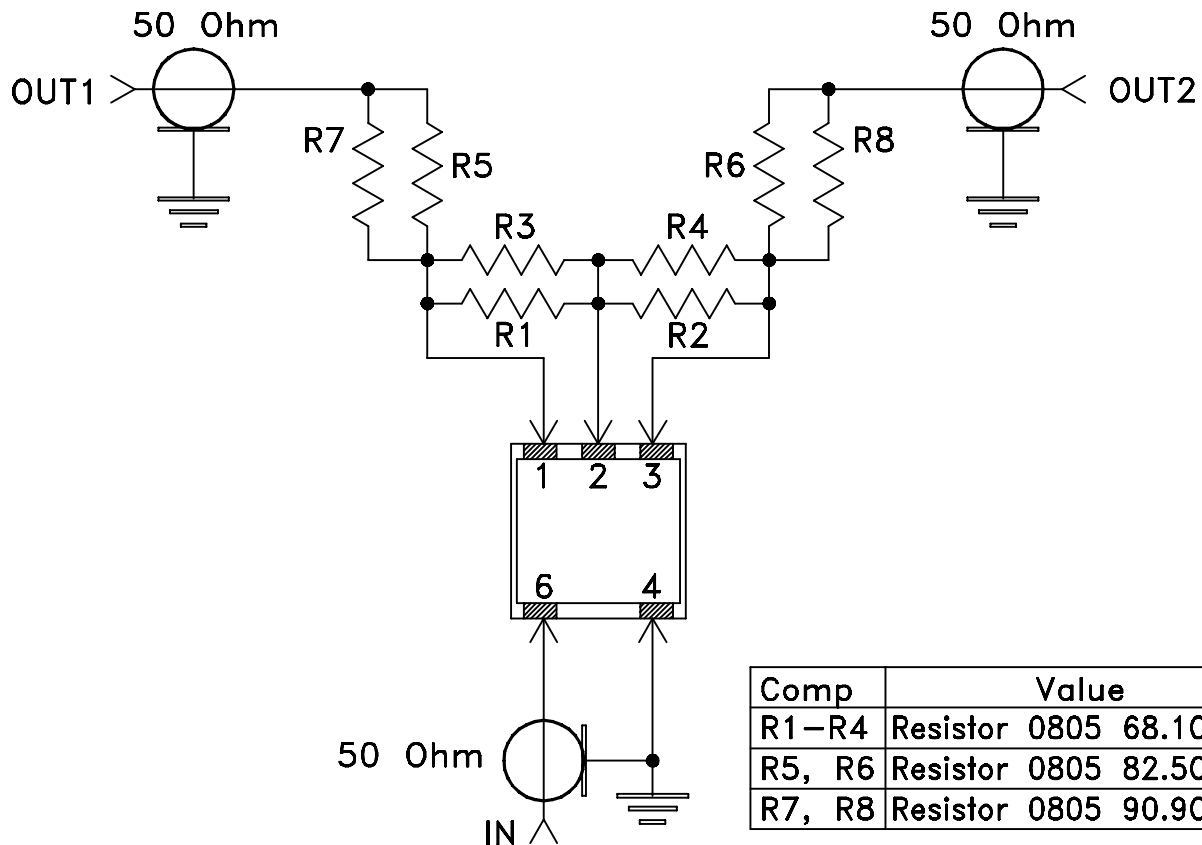
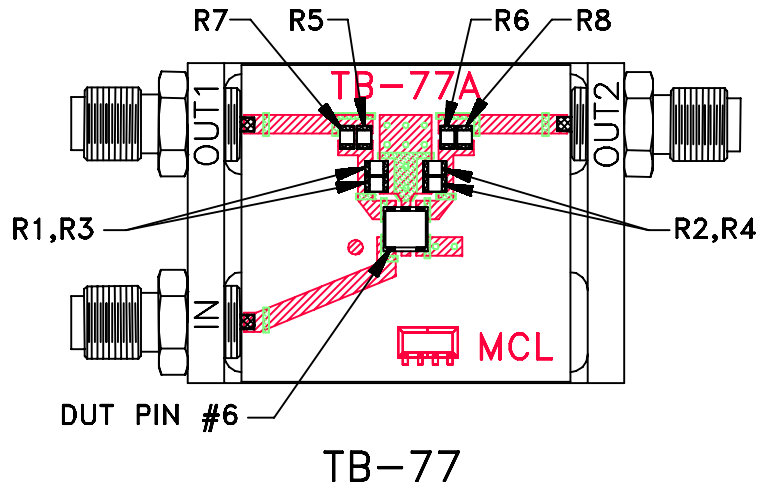
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PL, gs/ha/hd, AT224/DB714, TC/TCM

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 ASHEETA1.DWG REV:A DATE:01/12/95


SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-243	REV: OR
FILE: 98PL243	SCALE: 6:1	SHEET: 1 OF 1	

# Evaluation Board and Circuit



Schematic Diagram

1. 50 Ohm SMA Female Connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

 Mini-Circuits®





All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215